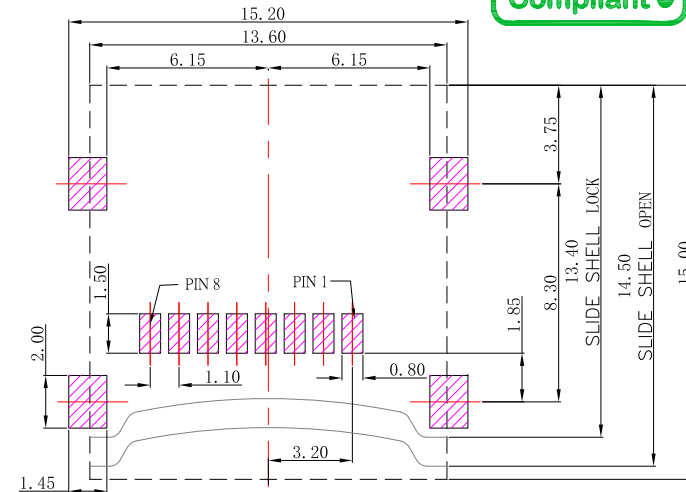
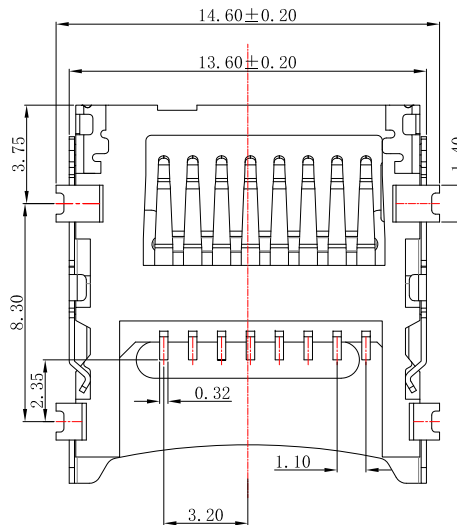
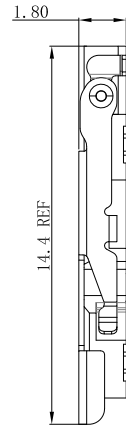
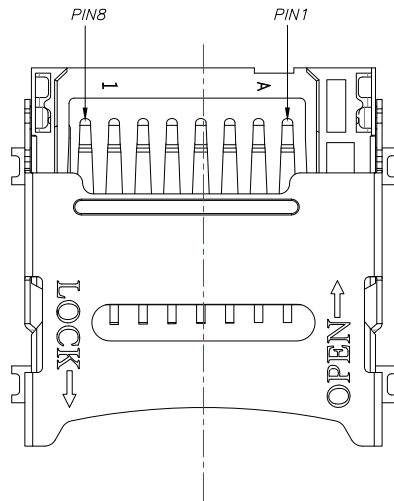




SLIDE SHELL LOCK

PCB LAYOUT

SPECIFICATION

Electrical :

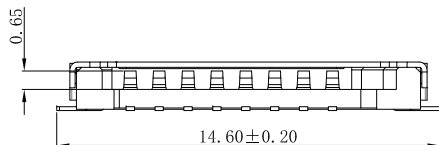
- Rating: 0.5A
- Contact Resistance: 50 mΩ Max.
- Insulation Resistance: 100 MΩ Min.
- Operating Temperature: -30°C ~85°C

Material:

- Housing: LCP
- Contact: Phosphor Bronze
- Shell: SUS

Finish:

- Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- Shell: Nickel under Plated surface layer



PIN NO.	PIN Assignmeng.
PIN1	DAT2
PIN2	CD/DAT3
PIN3	CMD
PIN4	VDD
PIN5	CLK
PIN6	VSS
PIN7	DAT0
PIN8	DAT1

6	新增PIN定義	Jack	102023
5	更新圖面	Jack	090523
4	更新樣式	LAN	042419
3	更新樣式	Jack	101118
2	更新為AO版	Jack	082918
1	更新料號	Jack	081618
ITEM NO	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle ± 0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE
Jack Lu	10/20/23
CHECKED BY:	DATE
Jacky Chen	10/20/23
APPROVED BY:	DATE
Tony Kao	10/20/23

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	Micro SD 卡座 H:1.8mm
SCALE	1 : 1	DWG NO.	SD-TF11-41808-S267
SHEET NO.	1 of 1	PART NO.	SD-TF11-41808-S267
		SIZE	A4
		VER	R6